

< High Voltage Insulated Gate Bipolar Transistor : HVIGBT >

CM1200E4C-34S1

HIGH POWER SWITCHING USE
INSULATED TYPE

CM1200E4C-34S1



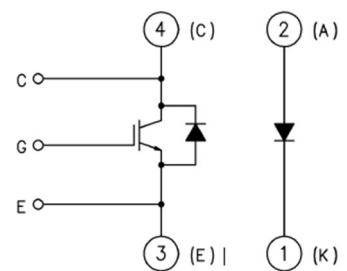
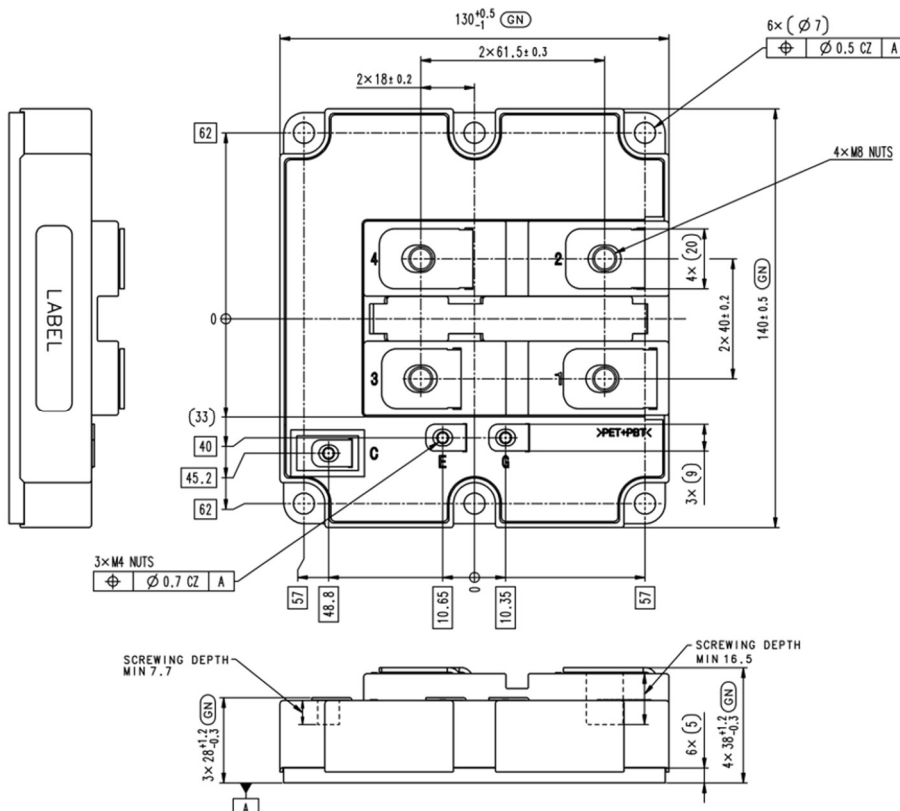
- I_C 1200A
- V_{CES} 1700V
- 2-elements in a Pack (for brake chopper)
- Insulated Type
- CSTBT™(III) / RFC Diode
- Flat Baseplate

APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



CIRCUIT DIAGRAM

< High Voltage Insulated Gate Bipolar Transistor : HVIGBT >

CM1200E4C-34S1**HIGH POWER SWITCHING USE
INSULATED TYPE****MAXIMUM RATINGS**

Item	Symbol	Conditions	Ratings	Unit
Collector-emitter voltage Gate-emitter short-circuited	V_{CES}	$V_{GE} = 0 \text{ V}$	$T_j = -40 \sim +150 \text{ }^{\circ}\text{C}$ $T_j = -50 \text{ }^{\circ}\text{C}$	1700 1650 V V
Gate-emitter voltage Collector-emitter short-circuited	V_{GES}	$V_{CE} = 0 \text{ V}$	$T_j = 25 \text{ }^{\circ}\text{C}$	± 20 V
Repetitive peak reverse voltage	V_{RRM}	(Note 1)	$T_j = -40 \sim +150 \text{ }^{\circ}\text{C}$ $T_j = -50 \text{ }^{\circ}\text{C}$	1700 1650 V
Collector current	I_C	$T_c = 90 \text{ }^{\circ}\text{C}$, DC		1200 A
(Repetitive peak) Collector current	I_{CRM}	Pulse (Note 2)		2400 A
Emitter current	I_E	DC (Note 3)		1200 A
(Repetitive peak) Emitter current	I_{ERM}	Pulse (Note 2, 3)		2400 A
Forward current	I_F	DC (Note 1)		1200 A
Repetitive peak forward current	I_{FRM}	Pulse (Note 1, 2)		2400 A
Total power dissipation	P_{tot}	$T_c = 25 \text{ }^{\circ}\text{C}$, IGBT part (Note 4)		6750 W
Isolation voltage	V_{isol}	Charged part to the baseplate RMS sinusoidal, 60Hz 1min		6000 V_{rms}
Partial discharge charge	Q_{pd}	Charged part to the baseplate, RMS sinusoidal, 60 Hz $V_1 = 3500 \text{ V}$, $V_2 = 2600 \text{ V}$, (acc. to IEC 61287-1)		10 pC
Junction temperature	T_j	Maximum temperature range in off-state or on-state (non-switching)		$-50 \sim +150$ $^{\circ}\text{C}$
Storage temperature	T_{stg}	Maximum case temperature range in off-state		$-50 \sim +150$ $^{\circ}\text{C}$
Operating junction temperature	T_{jop}	Maximum junction temperature range for switching operation		$-50 \sim +150$ $^{\circ}\text{C}$
Turn-off collector current	$I_{C(off)}$	$V_{GE} = \pm 15 \text{ V}$, $L_s = 70 \text{ nH}$, $R_{G(off)} = 3.3 \Omega$, $V_{CC} \leq 1200 \text{ V}$, $V_{CE} \leq 1700 \text{ V}$	$T_j = 150 \text{ }^{\circ}\text{C}$	2400 A
Short-circuit withstand pulse duration	t_{pSC}	$V_{GE} = \pm 15 \text{ V}$, $L_s = 70 \text{ nH}$, $R_{G(off)} = 3.3 \Omega$, $V_{CC} \leq 1200 \text{ V}$, $V_{CE} \leq 1700 \text{ V}$	$T_j = 150 \text{ }^{\circ}\text{C}$	10 μs
Reverse recovery power dissipation	P_{rr}	$I_E = 2400 \text{ A}$, $L_s = 70 \text{ nH}$, $V_{CC} \leq 1200 \text{ V}$, $di/dt \leq 8000 \text{ A}/\mu\text{s}$, $V_{CE} \leq 1700 \text{ V}$ (Note 3)	$T_j = 150 \text{ }^{\circ}\text{C}$	1.1 MW
Reverse recovery power dissipation	P_{rr}	$I_F = 2400 \text{ A}$, $L_s = 70 \text{ nH}$, $V_{CC} \leq 1200 \text{ V}$, $di/dt \leq 8000 \text{ A}/\mu\text{s}$, $V_{RM} \leq 1700 \text{ V}$ (Note 1)	$T_j = 150 \text{ }^{\circ}\text{C}$	1.1 MW
Non-repetitive surge forward current	I_{FSM}	$t_p = 10 \text{ ms}$, $V_R = 50 \text{ V}$, $F(t)_{weibull} = 1\%$, Half sine wave (Note 1)	$T_j = 150 \text{ }^{\circ}\text{C}$	5.1 kA
I^2t value	I^2t	$t_p = 10 \text{ ms}$, $V_R = 50 \text{ V}$, $F(t)_{weibull} = 1\%$, Half sine wave (Note 1)	$T_j = 150 \text{ }^{\circ}\text{C}$	130 kA^2s

ELECTRICAL CHARACTERISTICS

Item	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Collector-emitter cut-off current Gate-emitter short-circuited	I_{CES}	$V_{CE} = 1700 \text{ V}$, $V_{GE} = 0 \text{ V}$	$T_j = 25 \text{ }^{\circ}\text{C}$ $T_j = 125 \text{ }^{\circ}\text{C}$ $T_j = 150 \text{ }^{\circ}\text{C}$	- - -	- 1.8 40.0	mA mA mA
Peak reverse recovery current	I_{RRM}	$V_{RM} = 1700 \text{ V}$ (Note 1)	$T_j = 25 \text{ }^{\circ}\text{C}$ $T_j = 125 \text{ }^{\circ}\text{C}$ $T_j = 150 \text{ }^{\circ}\text{C}$	- 1.1 -	- - 25	mA mA mA
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = 10 \text{ V}$, $I_C = 120 \text{ mA}$	$T_j = 25 \text{ }^{\circ}\text{C}$	5.40	6.00	6.60 V
Gate leakage current Collector-emitter short-circuited	I_{GES}	$V_{CE} = 0 \text{ V}$, $V_{GE} = \pm 20 \text{ V}$	$T_j = 25 \text{ }^{\circ}\text{C}$	-0.5	-	0.5 μA
Gate charge	Q_G	$V_{CC} = 850 \text{ V}$, $I_C = 1200 \text{ A}$, $V_{GE} = \pm 15 \text{ V}$	$T_j = 25 \text{ }^{\circ}\text{C}$	-	12.0	- μC
Input capacitance	C_{ies}	$V_{CE} = 10 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$	$T_j = 25 \text{ }^{\circ}\text{C}$	-	216	- nF
Output capacitance	C_{oes}	$V_{CE} = 10 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$	$T_j = 25 \text{ }^{\circ}\text{C}$	-	8.0	- nF
Reverse transfer capacitance	C_{res}	$V_{CE} = 10 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$	$T_j = 25 \text{ }^{\circ}\text{C}$	-	1.6	- nF
Collector-emitter saturation voltage	V_{CESat}	$I_C = 1200 \text{ A}$, $V_{GE} = +15 \text{ V}$ Between Collector - Emitter auxiliary terminal (Note 5)	$T_j = 25 \text{ }^{\circ}\text{C}$ $T_j = 125 \text{ }^{\circ}\text{C}$ $T_j = 150 \text{ }^{\circ}\text{C}$	- - -	1.95 2.25 2.30	- - 2.80 V
Emitter-collector voltage	V_{EC}	$I_E = 1200 \text{ A}$, $V_{GE} = 0 \text{ V}$ Between Collector - Emitter auxiliary terminal (Note 3,5)	$T_j = 25 \text{ }^{\circ}\text{C}$ $T_j = 125 \text{ }^{\circ}\text{C}$ $T_j = 150 \text{ }^{\circ}\text{C}$	- - -	2.20 2.35 2.35	- - 2.85 V
Forward voltage	$V_{FM(Chip)}$	$I_F = 1200 \text{ A}$ (Note 1,5)	$T_j = 25 \text{ }^{\circ}\text{C}$ $T_j = 125 \text{ }^{\circ}\text{C}$ $T_j = 150 \text{ }^{\circ}\text{C}$	- - -	2.20 2.35 2.35	- - 2.85 V
Forward voltage	$V_{FM(Terminal)}$	$I_F = 1200 \text{ A}$ (Note 1,5)	$T_j = 25 \text{ }^{\circ}\text{C}$ $T_j = 125 \text{ }^{\circ}\text{C}$ $T_j = 150 \text{ }^{\circ}\text{C}$	- - -	2.43 2.63 2.64	- - - V

CM1200E4C-34S1**HIGH POWER SWITCHING USE
INSULATED TYPE****ELECTRICAL CHARACTERISTICS**

Item	Symbol	Conditions	Limits			Unit	
			Min.	Typ.	Max.		
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 850 \text{ V}$, $I_C = 1200 \text{ A}$, $V_{GE} = \pm 15 \text{ V}$, $L_s = 70 \text{ nH}$ $R_{G(on)} = 1.3 \Omega$, $R_{G(off)} = 3.3 \Omega$ Inductive load(Note 6)	$T_J = 150 \text{ }^{\circ}\text{C}$	-	-	1.10	μs
Rise time	t_r		$T_J = 150 \text{ }^{\circ}\text{C}$	-	-	0.41	μs
Turn-on (switching) energy per pulse 10% integral	$E_{on(10\%)}$		$T_J = 25 \text{ }^{\circ}\text{C}$	-	265	-	mJ
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	350	-	mJ
Turn-on (switching) energy per pulse	E_{on}		$T_J = 150 \text{ }^{\circ}\text{C}$	-	355	-	mJ
			$T_J = 25 \text{ }^{\circ}\text{C}$	-	290	-	mJ
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	370	-	mJ
			$T_J = 150 \text{ }^{\circ}\text{C}$	-	380	-	mJ
Reverse recovery time	t_{rr}	$V_{CC} = 850 \text{ V}$, $I_E = 1200 \text{ A}$, $V_{GE} = \pm 15 \text{ V}$, $L_s = 70 \text{ nH}$ $R_{G(on)} = 1.3 \Omega$, $R_{G(off)} = 3.3 \Omega$ Inductive load(Note 3,6,7)	$T_J = 25 \text{ }^{\circ}\text{C}$	-	0.30	-	μs
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	0.40	-	μs
			$T_J = 150 \text{ }^{\circ}\text{C}$	-	0.45	-	μs
Reverse recovery current	I_{rr}		$T_J = 25 \text{ }^{\circ}\text{C}$	-	735	-	A
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	865	-	A
			$T_J = 150 \text{ }^{\circ}\text{C}$	-	875	-	A
Reverse recovery charge 10% integral	$Q_{rr(10\%)}$		$T_J = 25 \text{ }^{\circ}\text{C}$	-	190	-	μC
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	295	-	μC
Reverse recovered charge	Q_{rr}		$T_J = 150 \text{ }^{\circ}\text{C}$	-	365	-	μC
			$T_J = 25 \text{ }^{\circ}\text{C}$	-	265	-	μC
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	340	-	μC
Reverse recovery energy per pulse 10% integral	$E_{rec(10\%)}$		$T_J = 150 \text{ }^{\circ}\text{C}$	-	420	-	μC
			$T_J = 25 \text{ }^{\circ}\text{C}$	-	90	-	mJ
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	150	-	mJ
Reverse recovery energy per pulse	E_{rec}		$T_J = 150 \text{ }^{\circ}\text{C}$	-	195	-	mJ
			$T_J = 25 \text{ }^{\circ}\text{C}$	-	150	-	mJ
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	190	-	mJ
				$T_J = 150 \text{ }^{\circ}\text{C}$	-	240	-
Reverse recovery time	t_{rr}	$V_{CC} = 850 \text{ V}$, $I_F = 1200 \text{ A}$, $V_{GE} = \pm 15 \text{ V}$, $L_s = 70 \text{ nH}$ $R_{G(on)} = 1.3 \Omega$, $R_{G(off)} = 3.3 \Omega$ Inductive load(Note 1,6,7)	$T_J = 25 \text{ }^{\circ}\text{C}$	-	0.30	-	μs
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	0.40	-	μs
			$T_J = 150 \text{ }^{\circ}\text{C}$	-	0.45	-	μs
Reverse recovery current	I_{rr}		$T_J = 25 \text{ }^{\circ}\text{C}$	-	735	-	A
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	865	-	A
			$T_J = 150 \text{ }^{\circ}\text{C}$	-	875	-	A
Reverse recovery charge 10% integral	$Q_{rr(10\%)}$		$T_J = 25 \text{ }^{\circ}\text{C}$	-	190	-	μC
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	295	-	μC
Reverse recovered charge	Q_{rr}		$T_J = 150 \text{ }^{\circ}\text{C}$	-	365	-	μC
			$T_J = 25 \text{ }^{\circ}\text{C}$	-	265	-	μC
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	340	-	μC
Reverse recovery energy per pulse 10% integral	$E_{rec(10\%)}$		$T_J = 150 \text{ }^{\circ}\text{C}$	-	420	-	μC
			$T_J = 25 \text{ }^{\circ}\text{C}$	-	90	-	mJ
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	150	-	mJ
Reverse recovery energy per pulse	E_{rec}		$T_J = 150 \text{ }^{\circ}\text{C}$	-	195	-	mJ
			$T_J = 25 \text{ }^{\circ}\text{C}$	-	150	-	mJ
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	190	-	mJ
				$T_J = 150 \text{ }^{\circ}\text{C}$	-	240	-
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 850 \text{ V}$, $I_C = 1200 \text{ A}$, $V_{GE} = \pm 15 \text{ V}$, $L_s = 70 \text{ nH}$ $R_{G(on)} = 1.3 \Omega$, $R_{G(off)} = 3.3 \Omega$ Inductive load(Note 6)	$T_J = 25 \text{ }^{\circ}\text{C}$	-	1.20	-	μs
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	1.30	-	μs
			$T_J = 150 \text{ }^{\circ}\text{C}$	-	1.32	-	μs
Fall time	t_f		$T_J = 25 \text{ }^{\circ}\text{C}$	-	0.12	-	μs
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	0.15	-	μs
			$T_J = 150 \text{ }^{\circ}\text{C}$	-	0.17	-	μs
Turn-off (switching) energy per pulse 10% integral	$E_{off(10\%)}$		$T_J = 25 \text{ }^{\circ}\text{C}$	-	200	-	mJ
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	280	-	mJ
Turn-off (switching) energy per pulse	E_{off}		$T_J = 150 \text{ }^{\circ}\text{C}$	-	310	-	mJ
			$T_J = 25 \text{ }^{\circ}\text{C}$	-	260	-	mJ
			$T_J = 125 \text{ }^{\circ}\text{C}$	-	360	-	mJ
				$T_J = 150 \text{ }^{\circ}\text{C}$	-	400	-

CM1200E4C-34S1**HIGH POWER SWITCHING USE
INSULATED TYPE****THERMAL CHARACTERISTICS**

Item	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Thermal resistance junction to case, IGBT	$R_{th(j-c)Q}$	Junction to Case, IGBT part, 1/2 module	-	-	18.5	K/kW
Thermal resistance Junction to case, DIODE	$R_{th(j-c)D}$	Junction to Case, FWDi part, 1/2 module	-	-	38.0	K/kW
Thermal resistance Junction to case, DIODE	$R_{th(j-c)D}$	Junction to Case, Clamp-Di part, 1/2 module	-	-	38.0	K/kW
Contact thermal resistance case to heatsink	$R_{th(c-s)}$	Case to heat sink, 1/2 module $\lambda_{grease} = 1 \text{ W/m}\cdot\text{k}$, $D_{(c-s)} = 100 \mu\text{m}$	-	16.0	-	K/kW

MECHANICAL CHARACTERISTICS

Item	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Mounting torque	M_t	Main terminals screw: M8	7.0	-	20.0	N·m
		Mounting screw: M6	3.0	-	6.0	N·m
		Auxiliary terminals screw: M4	1.0	-	3.0	N·m
Mass	m	-	-	0.8	-	kg
Comparative tracking index	CTI	-	600	-	-	-
Clearance distance in air	d_a	Collector main terminal - Emitter main terminal Terminal - Baseplate	19.5	-	-	mm
Creepage distance along surface	d_s	Collector main terminal - Emitter main terminal	32.0	-	-	mm
Creepage distance along surface	d_s	Terminal - Baseplate	32.0	-	-	mm
Internal inductance (C-E)	$L_{P(C-E)}$	1/2 module, IGBT part, $T_C=25^\circ\text{C}$	-	22	-	nH
Internal inductance (A-K)	$L_{P(A-K)}$	1/2 module, Clamp-Di part, $T_C=25^\circ\text{C}$	-	22	-	nH
Internal lead resistance, CC'-EE'	$R_{CC'+EE'}$	1/2 module, IGBT part, $T_C=25^\circ\text{C}$	-	0.19	-	mΩ
Internal lead resistance, AA'-KK'	$R_{AA'+KK'}$	1/2 module, Clamp-Di part, $T_C=25^\circ\text{C}$	-	0.19	-	mΩ
		1/2 module, Clamp-Di part, $T_C=125^\circ\text{C}$	-	0.23	-	mΩ
		1/2 module, Clamp-Di part, $T_C=150^\circ\text{C}$	-	0.24	-	mΩ

Note1. The symbols represent characteristics of the clamp diode (Clamp-Di).

Note2. Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed T_{jopmax} rating.Note3. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWD_i).Note4. Junction temperature (T_j) should not exceed T_{jmax} rating (150°C).

Note5. Pulse width and repetition rate should be such as to cause negligible temperature rise.

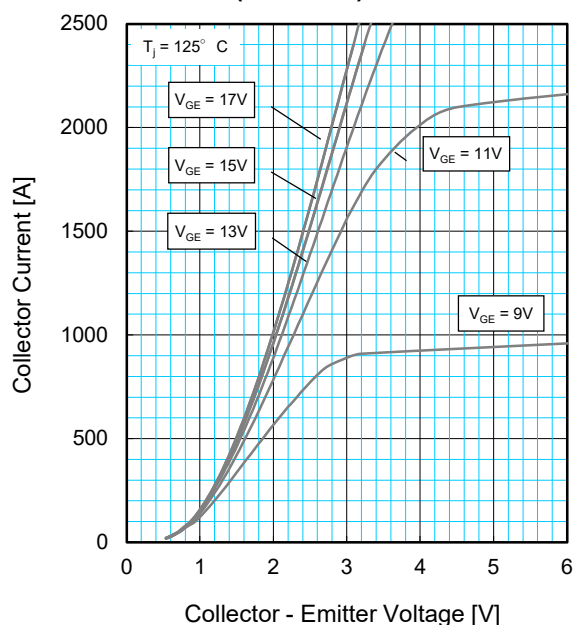
Note6. The integration range of switching energies($E_{on(10\%)}$, $E_{rec(10\%)}$, $E_{off(10\%)}$) is from $10\%V_{CE}$ to $10\%I_C(10\%I_E)$.Note7. The integration range of reverse recovery charge($Q_{rr(10\%)}$) is from $I_E = 0\text{A}$ to $10\%I_E$.

CM1200E4C-34S1

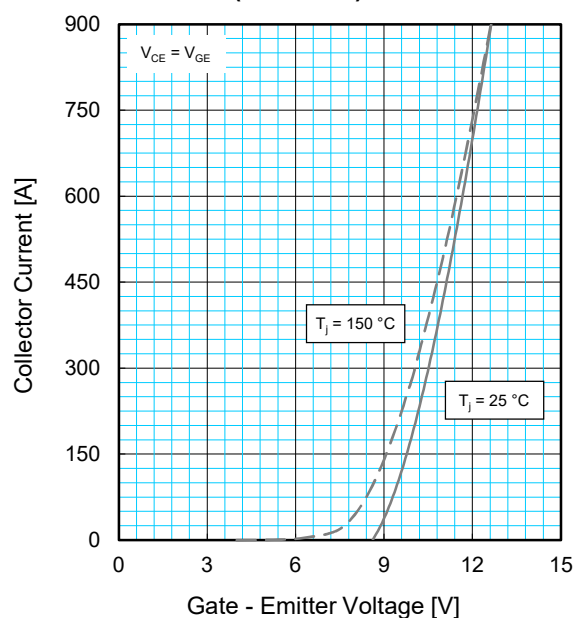
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

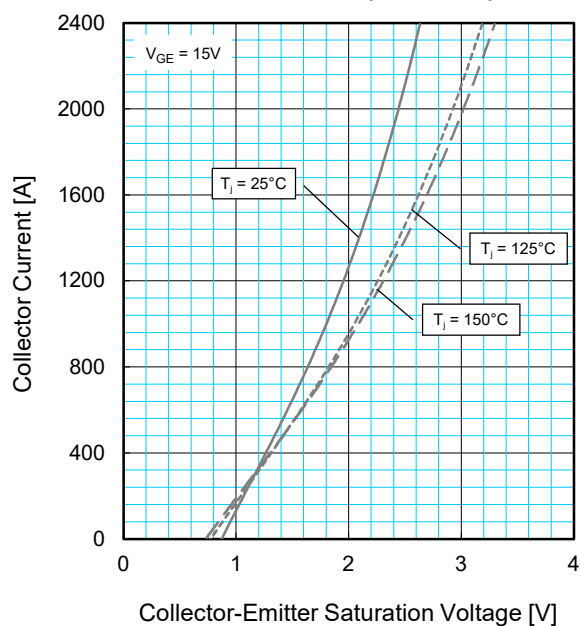
OUTPUT CHARACTERISTICS
(TYPICAL)



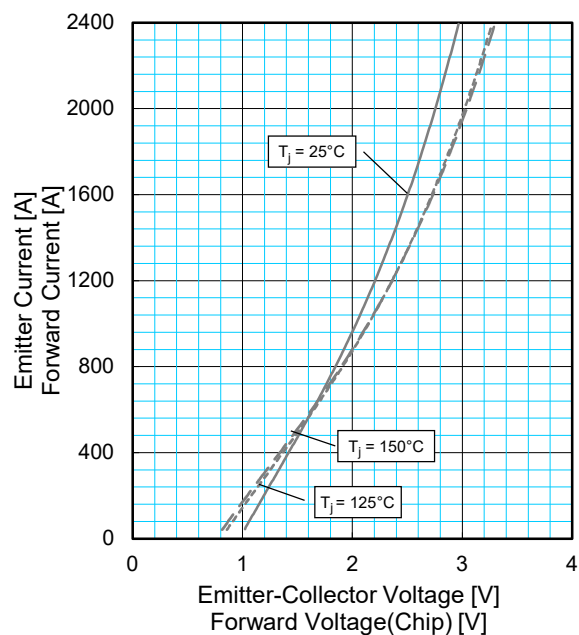
TRANSFER CHARACTERISTICS
(TYPICAL)



COLLECTOR-EMITTER SATURATION VOLTAGE
CHARACTERISTICS (TYPICAL)



DIODE FORWARD
CHARACTERISTICS (TYPICAL)

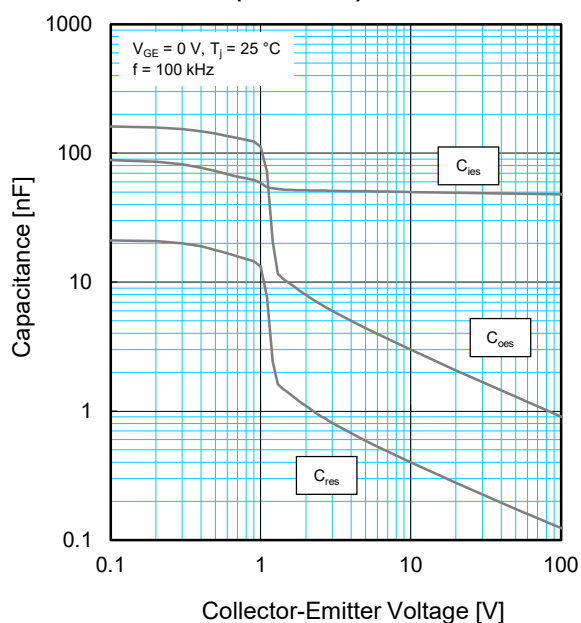


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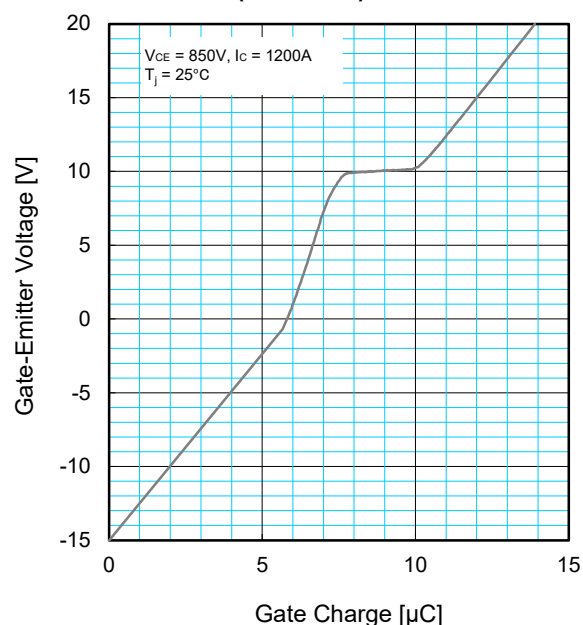
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

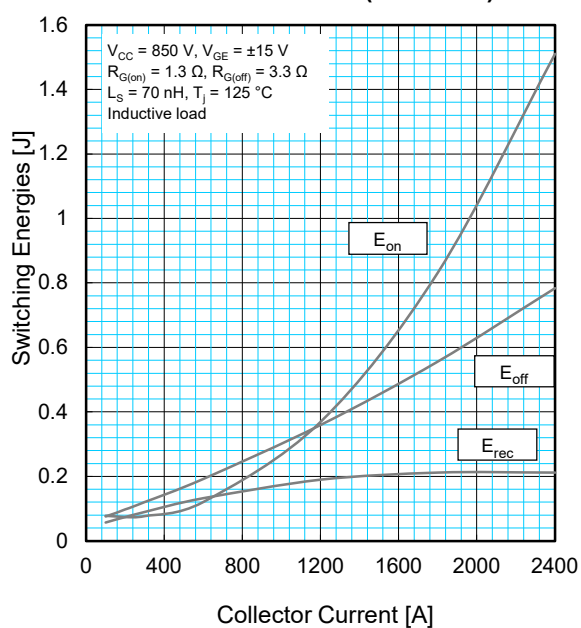
**CAPACITANCE CHARACTERISTICS
(TYPICAL)**



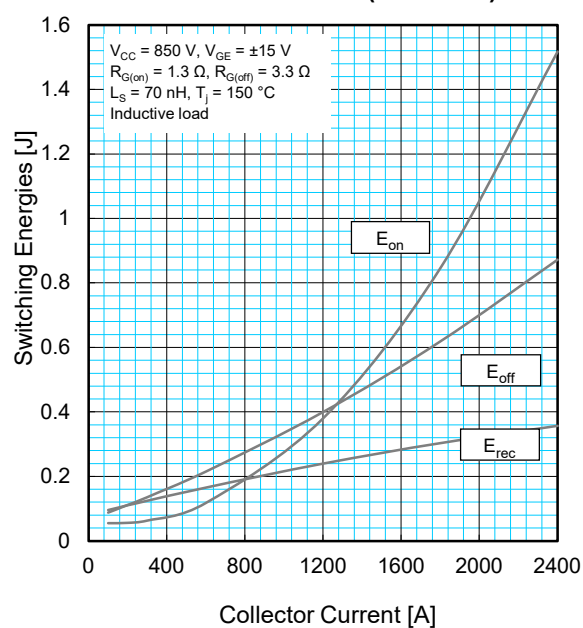
**GATE CHARGE CHARACTERISTICS
(TYPICAL)**



**HALF-BRIDGE SWITCHING ENERGY
CHARACTERISTICS (TYPICAL)**



**HALF-BRIDGE SWITCHING ENERGY
CHARACTERISTICS (TYPICAL)**

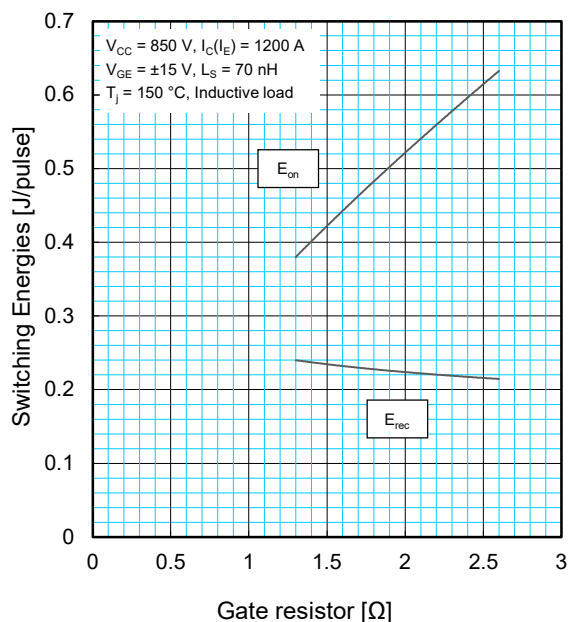


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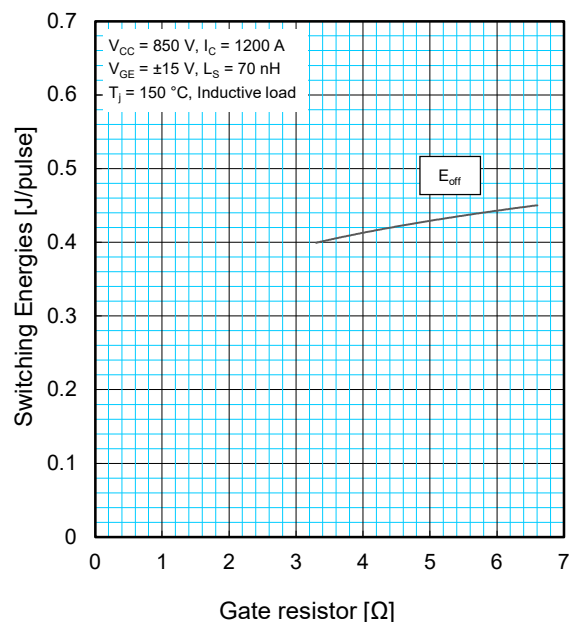
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

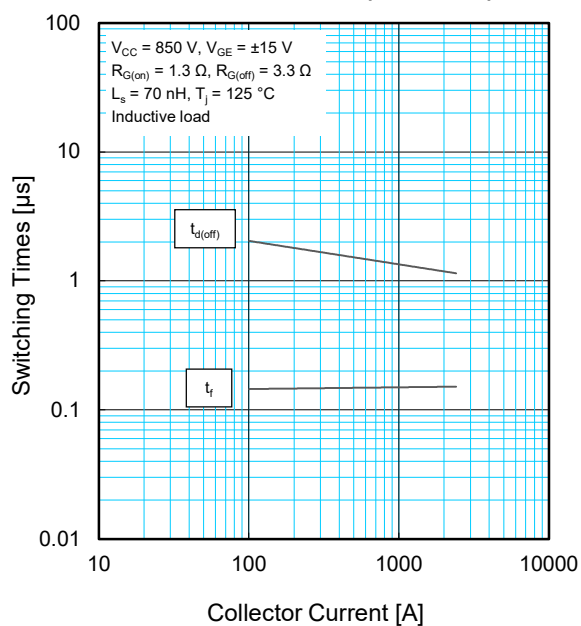
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



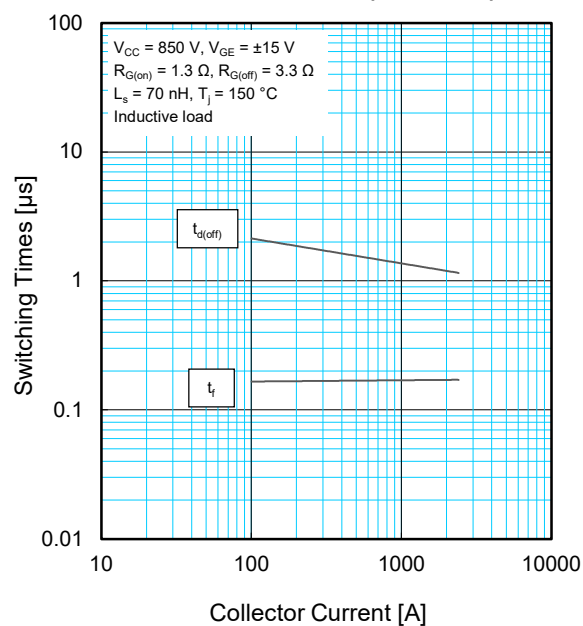
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

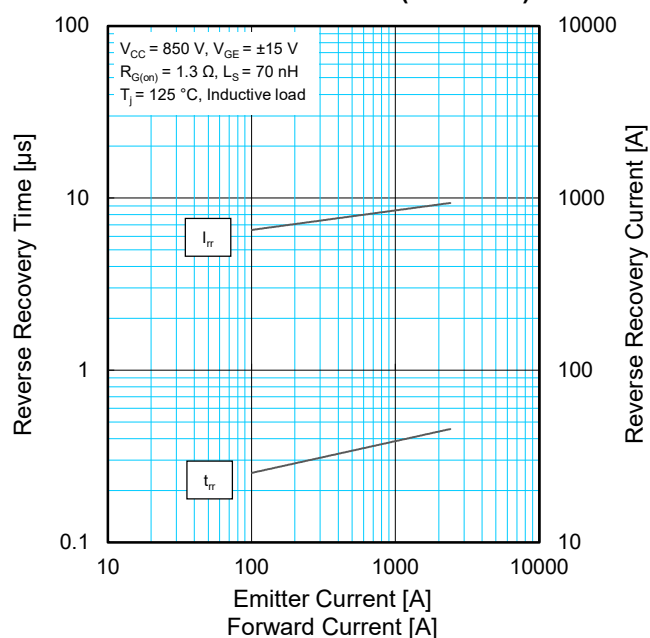
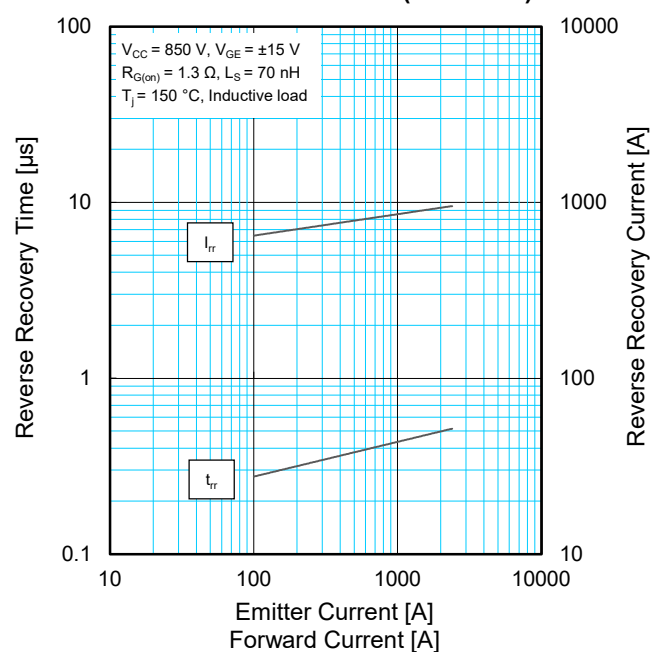
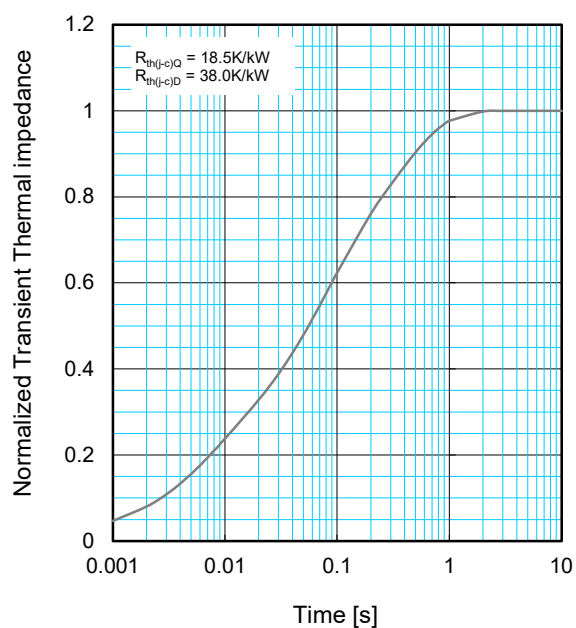


HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



CM1200E4C-34S1**HIGH POWER SWITCHING USE
INSULATED TYPE****PERFORMANCE CURVES****FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)****FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)****TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS**

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i \left\{ 1 - \exp\left(-\frac{t}{\tau_i}\right) \right\}$$

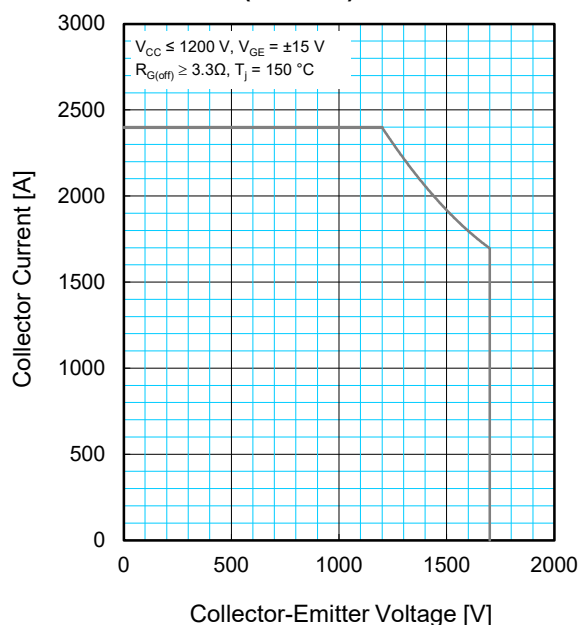
	1	2	3	4
R_i [K/kW] :	0.0096	0.1893	0.4044	0.3967
τ_i [sec.] :	0.0001	0.0058	0.0602	0.3512

CM1200E4C-34S1

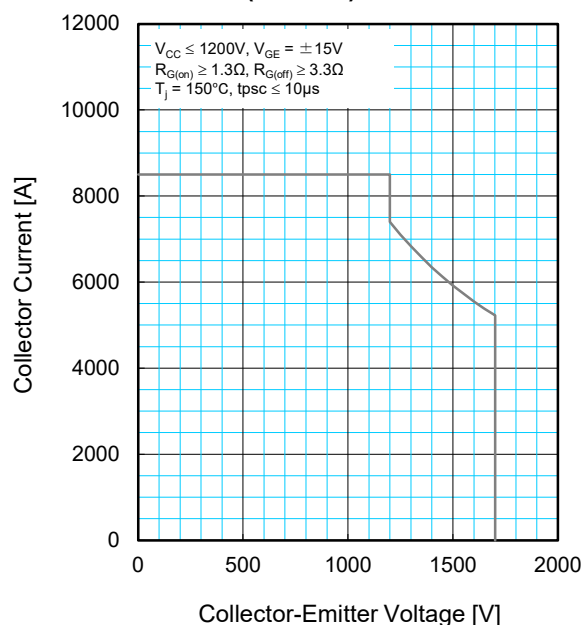
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

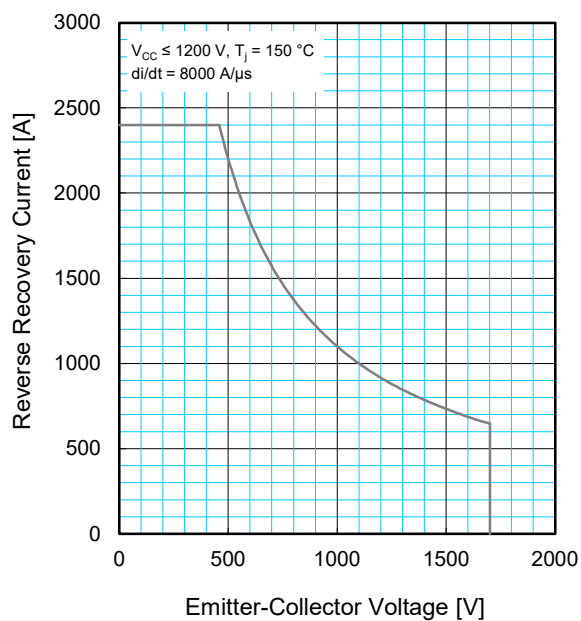
REVERSE BIAS SAFE OPERATING AREA
(RBSOA)



SHORT CIRCUIT SAFE OPERATING AREA
(SCSOA)



FREE-WHEEL DIODE REVERSE RECOVERY
SAFE OPERATING AREA (RRSOA)



CM1200E4C-34S1

HIGH POWER SWITCHING USE
INSULATED TYPE

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In usage of power semiconductor, there is always the possibility that trouble may occur with them by the reliability lifetime such as Power Cycle, Thermal Cycle or others, or when used under special circumstances (e.g. condensation, high humidity, dusty, salty, highlands, environment with lots of organic matter / corrosive gas / explosive gas, or situations which terminals of semiconductor products receive strong mechanical stress). Therefore, please pay sufficient attention to such circumstances. Further, depending on the technical requirements, our semiconductor products may contain environmental regulation substances, etc. If there is necessity of detailed confirmation, please contact our nearest sales branch or distributor.

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CM1200E4C-34S1

HIGH POWER SWITCHING USE
INSULATED TYPE

Keep safety first in your circuit designs!

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